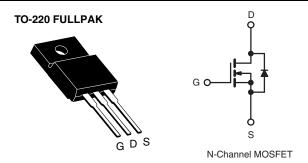


Vishay Siliconix

HALOGEN FREE

E Series Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	700)
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.18
Q _g max. (nC)	110)
Q _{gs} (nC)	15	
Q _{gd} (nC)	32	
Configuration	Sing	le



FEATURES

- Low figure-of-merit (FOM) R_{on} x Q_a
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFROMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF22N65E-E3
Lead (Pb)-free and Halogen-free	SiHF22N65E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	650	.,
Gate-Source Voltage		V_{GS}	± 30	V	
Continuous Drain Current (T, _I = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		22	
Continuous Drain Current (1) = 150 C)	VGS at 10 V	T _C = 100 °C	ID	14	Α
Pulsed Drain Current ^a			I _{DM}	56	
Linear Derating Factor				1.8	W/°C
Single Pulse Avalanche Energy b			E _{AS}	691	mJ
Maximum Power Dissipation			P _D	35	W
Operating Junction and Storage Temperature Range	Э		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	T _J = 125 °C		-11 / / -14	70	1//
Reverse Diode dV/dt d			dV/dt	26	V/ns
Soldering Recommendations (Peak Temperature) c for 10 s		10 s		300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.



Vishay Siliconix

THERMAL RESISTANCE RATI	NGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	65	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.6			

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	=.	0.74	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
Cata Caurea Laglaga		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	=.	± 1	μΑ
Zava Cata Valtaga Dvain Cuwant		V _{DS} =	= 650 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 520 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 11 A	-	0.15	0.18	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 8 V, I _D = 5 A		-	6.7	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	2415	-	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 100 V, f = 1 MHz		-	118	-	pF
Reverse Transfer Capacitance	C _{rss}			-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	89	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	307	-	
Total Gate Charge	Q_g			-	73	110	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 11 A, V_{DS} = 520 V$	-	15	-	nC
Gate-Drain Charge	Q _{gd}	1		-	32	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 520 \text{ V}, I_{D} = 11 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	22	45	- ns
Rise Time	t _r			-	33	66	
Turn-Off Delay Time	t _{d(off)}			-	73	110	
Fall Time	t _f			-	38	76	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.64	-	Ω
Drain-Source Body Diode Characteristic	s						•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	
Pulsed Diode Forward Current	I _{SM}			-	-	56	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 11 A, dl/dt = 100 A/ μ s, V _R = 400 V		-	400	-	ns
Reverse Recovery Charge	Q _{rr}			-	5.9	-	μC
Reverse Recovery Current	I _{RRM}			_	20	 -	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

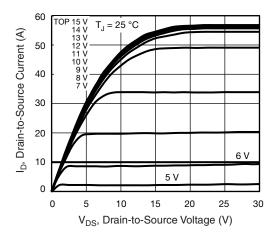


Fig. 1 - Typical Output Characteristics

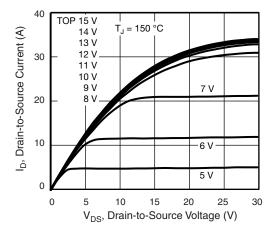


Fig. 2 - Typical Output Characteristics

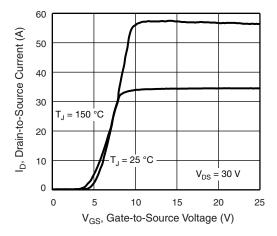


Fig. 3 - Typical Transfer Characteristics

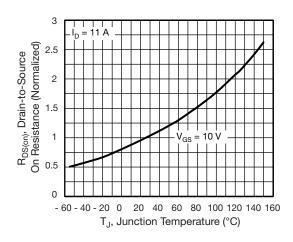


Fig. 4 - Normalized On-Resistance vs. Temperature

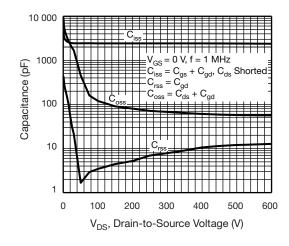


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

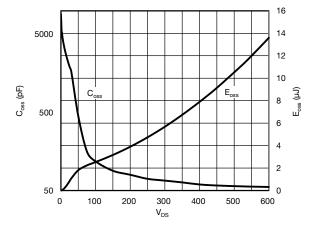


Fig. 6 - Coss and Eoss vs. VDS



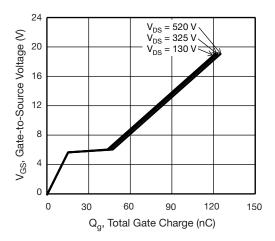


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

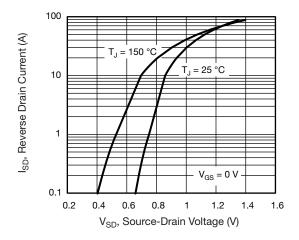


Fig. 8 - Typical Source-Drain Diode Forward Voltage

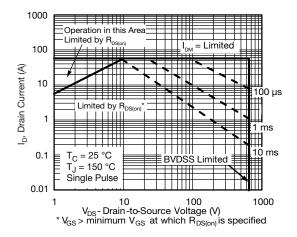


Fig. 9 - Maximum Safe Operating Area

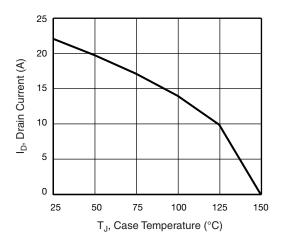


Fig. 10 - Maximum Drain Current vs. Case Temperature

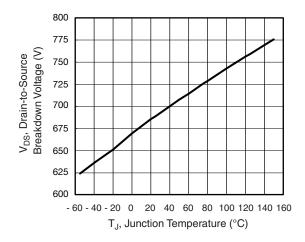


Fig. 11 - Temperature vs. Drain-to-Source Voltage



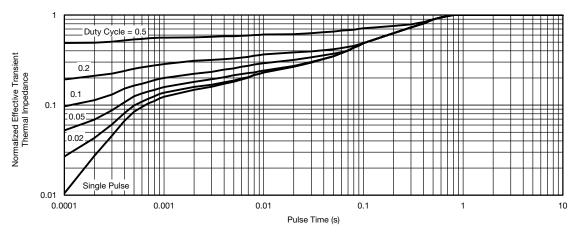


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

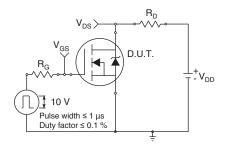


Fig. 13 - Switching Time Test Circuit

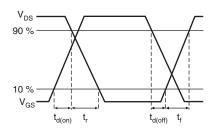


Fig. 14 - Switching Time Waveforms

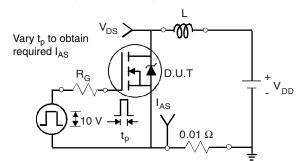


Fig. 15 - Unclamped Inductive Test Circuit

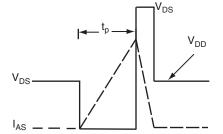


Fig. 16 - Unclamped Inductive Waveforms

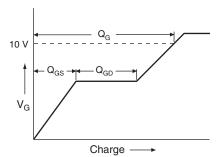


Fig. 17 - Basic Gate Charge Waveform

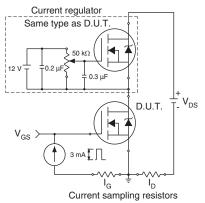
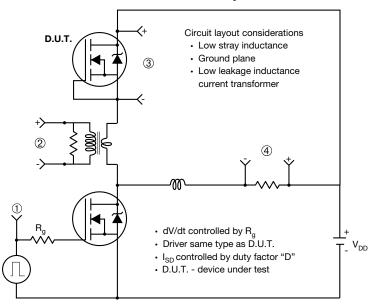


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



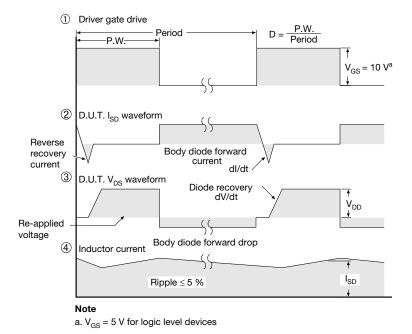


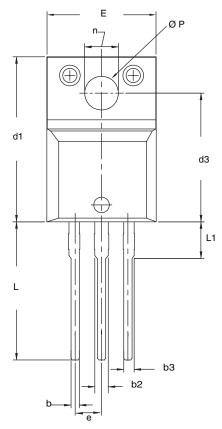
Fig. 19 - For N-Channel

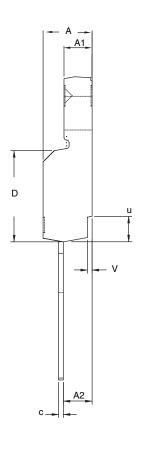
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TO-220 FULLPAK (HIGH VOLTAGE)





	MILLII	METERS	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
С	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
E	10.360	10.630	0.408	0.419
е	2.54	BSC	0.100 BSC	
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
ØΡ	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
V	0.400	0.500	0.016	0.020

EUN: X09-0126-Rev. B, 26-Oct-09 DWG: 5972

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
- 4. All dimensions include burrs and plating thickness.
- 5. No chipping or package damage.

Document Number: 91359 Revision: 26-Oct-09



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